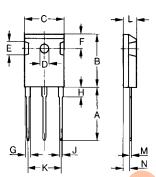
SDD25NXX

Discrete Diodes



	V RSM	VRRM
	V	V
SDD25N01	100	100
SDD25N02	200	200
SDD25N04	400	400
SDD25N08	800	800
SDD25N10	1000	1000
SDD25N12	1200	1200
SDD25N16	1600	1600



Dimensions TO-247AD



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
Α	19.81	20.32	0.780	0.800
В	20.80	21.46	0.819	0.845
С	15.75	16.26	0.610	0.640
D	3.55	3.65	0.140	0.144
Е	4.32	5.49	0.170	0.216
F	5.4	6.2	0.212	0.244
G	1.65	2.13	0.065	0.084
Н	-	4.5	-	0.177
J	1.0	1.4	0.040	0.055
K	10.8	11.0	0.426	0.433
L	4.7	5.3	0.185	0.209
M	0.4	8.0	0.016	0.031
N	1.5	2.49	0.087	0.102

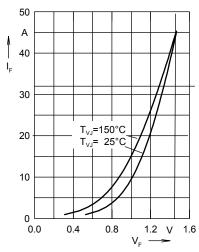
Symbol	Test Conditions	Maximum Ratings	Unit
IFRMS IF(AV)M	TvJ=TvJM Tc=100°C; 180° sine	43 28	Α
İFSM	$Tv_J = 45^{\circ}C;$ $t = 10ms (50Hz), sine$ $V_R = 0V;$ $t = 8.3ms (60Hz), sine$ $Tv_J = 150^{\circ}C;$ $t = 10ms (50Hz), sine$ $V_R = 0V;$ $t = 8.3ms (60Hz), sine$	300 330 270 300	A
l ² t	Tvj=45°C; t=10ms (50Hz), sine VR =0V; t=8.3ms (60Hz), sine Tvj=150°C; t=10ms(50Hz), sine VR =0V; t=8.3ms(60Hz), sine	450 450 340 325	A ² s
TvJ TvJM Tstg		-40+180 180 -40+150	°C
M _d Fc	Mounting torque Mounting force with clip	0.81.2 20120	Nm N
Weight	Typical	6	g

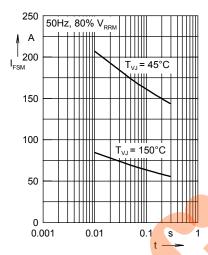
Symbol	Test Conditions	Characteristic Values	Unit
IR	Tvj=150°C; Vr=Vrrm	≤2	mA
VF	IF=25A; TvJ=25°C	≤ 1.25	V
V TO	For power-loss calculations only	0.8	V
r T	TvJ=TvJM	15	mΩ
RthJC	DC current	1.5	K/W
RthCK	DC current (with heatsink compound) typ.	0.4	



SDD25NXX

Discrete Diodes





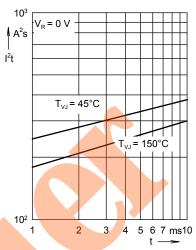
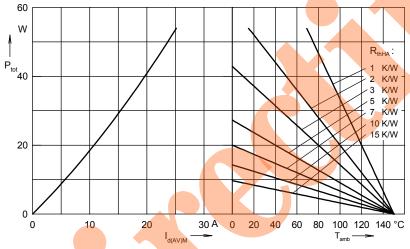


Fig. 1 Forward current versus voltage drop per diode

Fig. 2 Surge overload current

Fig. 3 I2t versus time per diode



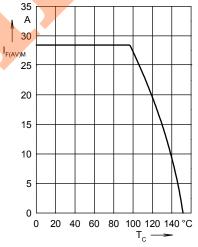


Fig. 4 Power dissipation versus direct output current and ambient temperature, sine 180 °

Fig. 5 Max. forward current versus case temperature

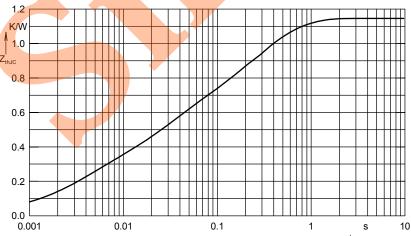


Fig. 6 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R _{thi} (K/W)	t _i (s)
1	0.01362	0.0001
2	0.1962	0.00316
3	0.267	0.023
4	0.3052	0.4
5	0.218	0.15

